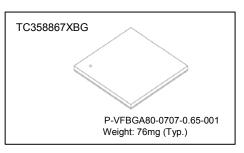
CMOS Digital Integrated Circuit Silicon Monolithic

TC358867XBG

Mobile Peripheral Devices

Overview

TC358867XBG is a bridge device that enables video streaming from a Host (application or baseband processor) over MIPI® DSI or DPI link to drive DisplayPortTM display panels. TC358867XBG also supports audio streaming from the host via I2S interface to the Display panels. TC358867XBG provides a low power bridge solution to efficiently translate MIPI® DSI or DPI transfers to DisplayPortTM transfers. As the



DisplayPortTM uses fewer wires compared to other existing display panel standards, it simplifies the LCD connectivity. The effect of using TC358867XBG is to enable existing baseband devices supporting DSI or DPI streaming to connect to new panels supporting DisplayPortTM interface and also to connect to existing panels over longer distance using DisplayPortTM adaptors at far-end.

Features

- Translates MIPI[®] DSI/DPI Link video stream from Host to DisplayPortTM Link data to external display devices.
- The inputs are driven by a DSI Host with 4-Data Lanes, upto1 Gbps/lane or DPI Host with 16/18/24 bit interface upto154 MHz parallel clock.
- (Optional) Supports HDCP Digital Content Protection version 1.3 (DisplayPortTM amendment Rev1.1).
- Embeds audio information from the I2S port into the DisplayPort[™] data stream.
- The output Interface consists of a DisplayPort[™]
 Tx with a 2-lane Main Link and AUX-Ch.
- Register Configuration: From DSI link or I²C interface.
- Interrupt to host to inform any error status or status needing attention from Host.
- Internal test pattern (color bar) generator for DP o/p testing without any video (DSI/DPI) i/p.
- Debug/Test Port: I2C Slave

DSI Receiver

- ♦ MIPI® DSI: v1.01 / MIPI® D-PHY: v0.90 Compliant.
- Up to four (4) Data Lanes with Bi-direction support on Data Lane 0.
- ♦ Maximum speed at 1 Gbps/lane.
- Supports Burst as well as Non-Burst Mode Video Data.
- Video data packets are limited to one row per Hsync period.
- Supports video stream packets for video data transmission.

- Supports generic long packets for accessing the chip's register set.
- Video input data formats:
- RGB-565, RGB-666 and RGB-888.
- New DSI V1.02 Data Type Support: 16-bit YCbCr 422
- ♦ Interlaced video mode is not supported.

• DPI Receiver

- ♦ Up to 16 / 18 / 24 bit parallel data interface.
- → Maximum speed at 154 MPs (Mpixel per sec).
- ♦ Video input data formats: RGB-565, RGB-666 and RGB-888.
- ♦ Only Progressive mode supported.
- I2S Audio Interface: Supports one I2S port for audio streaming from the host to TC358867XBG.
- Supports slave mode (BCLK, LRCLK & oversampling clock input from Host).
- ♦ Supports sampling frequencies of 32, 44.1, 48, 88.2, 96, 176.4 & 192 kHz.
- ♦ Supports up to 2 audio channels.
- ♦ Supports 16, 18, 20 or 24bits per sample.
- ♦ Optionally inserts IEC60958 status bits and preamble bits per channel.
- DisplayPortTM Interface: Supports a
 DisplayPortTM link from TC358867XBG to
 display panels.
- → High speed serial bridge chip using VESA® DisplayPort™ 1.1a Standard.
- Supports one dual-lane DisplayPort[™] port for high bandwidth applications
- ♦ Support 1.62 or 2.7 Gbps/lane data rate with voltage swings @0.4, 0.6, 0.8 or 1.2 V
- ♦ Support of pre-emphasis levels of 0, 3.5dB and 6dB.



- Supports Audio related Secondary Data Packets.
- ♦ AUX channel supported at 1 Mbps.
- ♦ HPD support through GPIO based interrupts
- Enhanced mode supported for content protection.
- ♦ (Optional) Support HDCP encryption Version 1.3 with DisplayPortTM amendment Revision 1.1.
- Secure ASSR (Alternate Scrambler Seed Reset) support.
- Stream Policy Maker is assumed handled by the Host (software/firmware).
- Start Link training in response to HPD & read final Link training status
- Configure DP link for actual video streaming & start video streaming
- Link Policy maker is assumed shared between the Host and TC358867XBG chip.
 - In auto_correction = 0 mode, control link training
- Initiate Display device capabilities read and configure TC358867XBG accordingly.
- Video timing generation as per panel requirement.
- SSCG with to 30 kHz modulation to reduce EMI.
- ♦ Built in PRBS7 Generator to test DisplayPortTM Link.

• RGB Parallel Output Interface:

- → RGB888 output (DisplayPortTM disabled) with only DSI input supported in this mode
- ♦ PCLK max. = 100 MHz
- → Polarity control for PCLK, VSYNC, HSYNC & DE

• I2C Interface:

- I²C slave interface for chip register set access enabled using a boot-strap option.
- → I²C compliant slave interface support for normal (100 kHz) and fast mode (400 kHz).

GPIO Interface:

- ♦ 2 bits of GPIO (shared with other digital logic).
- ♦ Direction controllable by Host I²C accesses.

Clock Source:

- DisplayPort™ clock source is from an external clock input or clock from DSI interface (13, 26, 19.2 or 38.4 MHz) – generates all internal & output clocks to interfacing display devices.
- → Built-in PLLs generate high-speed DisplayPortTM link clock requiring no external components. These PLLs are part of the DisplayPortTM PHY.
- Clock and power management support to achieve low power states.

• Possible modes of Operation:

- → MODE S21: TC358867XBG uses DisplayPortTM
 Tx as single 2-lane DisplayPortTM link to
 interface to single DisplayPortTM display device.
 Video stream source is from MIPI[®] DSI Host.
- → MODE P21: TC358867XBG uses DisplayPortTM
 Tx as single 2-lane DisplayPortTM link to
 interface to single DisplayPortTM display device.
 Video stream source is from MIPI® DPI Host.
- → MODE S2P: TC358867XBG uses only Parallel output port and disables DisplayPortTM Tx to interface to single RGB display device. Video stream source is from MIPI[®] DSI Host.

Power supply inputs

♦ Core and MIPI® D-PHY: $1.2 \text{ V} \pm 0.06 \text{ V}$ ♦ Digital I/O: $1.8 \text{ V} \pm 0.09 \text{ V}$ • DisplayPortTM: $1.8 \text{ V} \pm 0.09 \text{ V}$ • DisplayPortTM: $1.2 \text{ V} \pm 0.06 \text{ V}$

Power Consumptions (Typical value based on estimations)

♦ Power-down mode (DSI-Rx in ULPS, DP PHY & PLLs disabled, clocks stopped):

- DSI Rx: 0.01 mW - DP PHY: 2.34 mW - PLL9: 0.01 mW - Core: 0.96 mW - Rest: 0.01 mW

♦ Normal operation (1920 × 1080 resolution with DSI-Rx in 4-lane @925 Mbps per lane, DP PHY in dual lane link @2.7 Gbps per lane):

- DSI Rx: 21.79 mW - DP PHY: 142.70 mW - PLL9: 2.42 mW - Core: 87.64 mW - IOs: 1.68 mW

Package

0.65mm ball pitch, 80 balls, 7 × 7 mm BGA package

Rev.1.1



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- 2. MIPI® DPI, "MIPI Alliance Standard for Display Pixel Interface (DPI-2) Version 2.00 15 September 2005"
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- 8. Draft CEA-861-C, A DTV Profile for Uncompressed High Speed Digital Interfaces (Doc. Number: CEA-861rCv9.pdf (PNXXX)) Date: 05/04/2005
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1. Overview

The DSI/DPI to DisplayPortTM converter (TC358867XBG) is a bridge device that enables video streaming from a Host (application or baseband processor) over MIPI® DSI or DPI link to drive DisplayPortTM display panels. TC358867XBG also supports audio streaming from the host via I2S interface to the Display panels. TC358867XBG provides a low power bridge solution to efficiently translate MIPI® DSI or DPI transfers to DisplayPortTM transfers. As the DisplayPortTM uses fewer wires compared to other existing display panel standards, it simplifies the LCD connectivity. The effect of using TC358867XBG is to enable existing baseband devices supporting DSI or DPI streaming to connect to new panels supporting DisplayPortTM interface and also to connect to existing panels over longer distance using DisplayPortTM adaptors at far-end.

The chip can be configured through the DSI link by sending write/read register commands through DSI Generic Long Write packets. It can also be configured through the I²C Slave interface.

The DSI-RX receiver supports from 1 to 4-Lane configurations at bit rate up to 1 Gbps per lane. Host can transmit video in continuous video streaming mode. Host controls video timing by sending video frame and line sync events together with video pixel data; video data transmission can be burst or non-burst. Since the chip integrates only a small video buffer, Host still has to take care of transmitting pixel data at appropriate video line time in order to avoid buffer overflow (or underflow).

The DPI-Rx receiver supports 16, 18 or 24 bits parallel interface along with the required control signals for the Pixel clock and HSync/VSync/DE.

The TC358867XBG also supports content protection using HDCP copy protection(Optional).

The DisplayPort[™] transmitter supports data throughput at 1.62 Gbps or 2.7 Gbps per lane of main link. TC358867XBG supports three configuration modes. These modes mainly differ based on the source of input stream and output interface..

- Mode_S21: A system configuration where TC358867XBG may typically be used is shown in Figure 1.1. In this configuration, the TC358867XBG can support displays with resolution up to WUXGA (1920×1200) at 24bit, 60 fps or WUXGA (1920×1200) at 18bit, 60 fps. Video stream source is from DSI Host.
- Mode_P21: A system configuration where TC358867XBG may typically be used is shown in Figure 1.2. This is similar to the Mode_S21 except that the video stream source is from DPI Host. In this configuration, the TC358867XBG can support displays with resolution up to WUXGA (1920×1200) at 24bit, 60 fps.
- Mode_S2P: A system configuration where TC358867XBG may typically be used is shown in Figure 1.3. In this mode, DisplayPort[™] output is not used and the chip rather behaves as a DSI to RGB convertor. In this system, TC358867XBG could be connected to a single display. In this configuration, the TC358867XBG can support displays with resolution up to WXGA (1280x800 or 1366x768). Maximum output PCLK is 100MHz. Video stream source is from DSI Host.



The chip supports power management to conserve power when its functions are not in use. Host manages the chip's power consumption modes by using ULPS messages over DSI link during DPI input mode.

The following figures show all these modes, where TC358867XBG, display panels and a Host are connected in target Reference system for mobile large display panel applications.

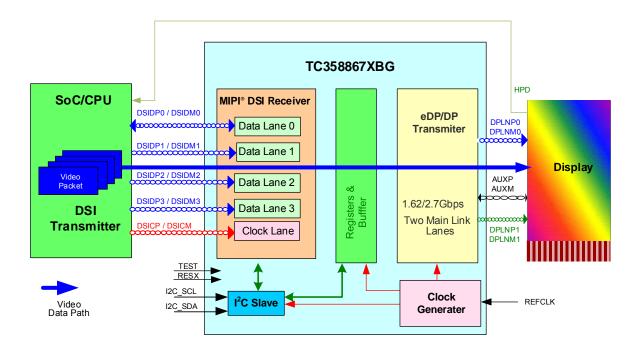


Figure 1.1 System Overview with TC358867XBG in MODE_S21 Configuration

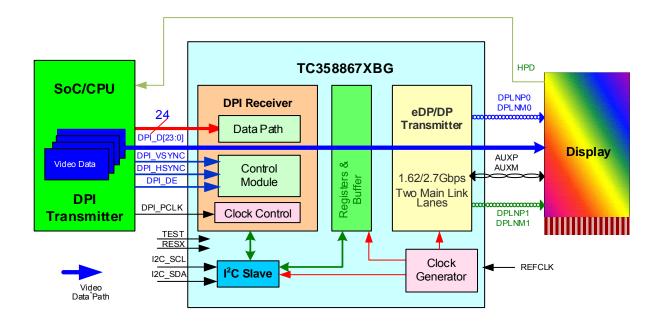


Figure 1.2 System Overview with TC358867XBG in MODE_P21 Configuration

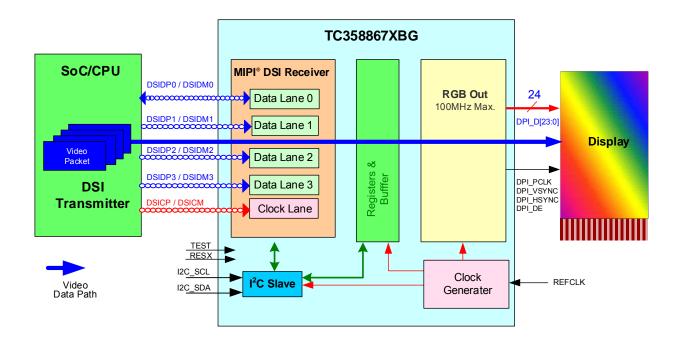


Figure 1.3 System Overview with TC358867XBG in MODE_S2P Configuration



2. Features

Below are the main features supported by TC358867XBG.

- Translates MIPI® DSI/DPI Link video stream from Host to DisplayPort™ Link data to external display devices.
- The inputs are driven by a DSI Host with 4-Data Lanes, upto1 Gbps/lane or DPI Host with 16/18/24 bit interface upto 154 MHz parallel clock.
- (Optional) Supports HDCP Digital Content Protection version 1.3 (DisplayPortTM amendment Rev1.1).
- Embeds audio information from the I2S port into the DisplayPortTM data stream.
- The output Interface consists of a DisplayPortTM Tx with a 2-lane Main Link and AUX-Ch.
- Register Configuration: From DSI link or I²C interface.
- Interrupt to host to inform any error status or status needing attention from Host.
- Internal test pattern (color bar) generator for DP o/p testing without any video (DSI/DPI) i/p.
- Debug/Test Port: I2C Slave

DSI Receiver

- ♦ MIPI® DSI: v1.01 / MIPI® D-PHY: v0.90 Compliant.
- ♦ Up to four (4) Data Lanes with Bi-direction support on Data Lane 0.
- ♦ Maximum speed at 1 Gbps/lane.
- ♦ Supports Burst as well as Non-Burst Mode Video Data.
 - Video data packets are limited to one row per Hsync period.
- ♦ Supports video stream packets for video data transmission.
- ♦ Supports generic long packets for accessing the chip's register set.
- ♦ Video input data formats:
 - RGB-565. RGB-666 and RGB-888.
 - New DSI V1.02 Data Type Support: 16-bit YCbCr 422
- ♦ Interlaced video mode is not supported.

DPI Receiver

- ♦ Up to 16 / 18 / 24 bit parallel data interface.
- ♦ Maximum speed at 154 MPs (MPixel per sec).
- ♦ Video input data formats: RGB-565, RGB-666 and RGB-888.
- ♦ Only Progressive mode supported.
- I2S Audio Interface: Supports one I2S port for audio streaming from the host to TC358867XBG.
 - ♦ Supports slave mode (BCLK, LRCLK & over-sampling clock input from Host).
 - ♦ Supports sampling frequencies of 32, 44.1, 48, 88.2, 96, 176.4 & 192 kHz.
 - ♦ Supports up to 2 audio channels.
 - ♦ Supports 16, 18, 20 or 24 bits per sample.
 - ♦ Optionally inserts IEC60958 status bits and preamble bits per channel.
- **DisplayPort™ Interface:** Supports a DisplayPort™ link from TC358867XBG to display panels.

 - → High speed serial bridge chip using VESA® DisplayPortTM 1.1a Standard.
 → Supports one dual-lane DisplayPortTM port for high bandwidth applications.
 - ♦ Support 1.62 or 2.7 Gbps/lane data rate with voltage swings @0.4, 0.6, 0.8 or 1.2 V.
 - ♦ Support of pre-emphasis levels of 0, 3.5 dB and 6 dB.
 - ♦ Supports Audio related Secondary Data Packets.
 - ♦ AUX channel supported at 1 Mbps.
 - ♦ HPD support through GPIO based interrupts
 - ♦ Enhanced mode supported for content protection.
 - ♦ (Optional) Support HDCP encryption Version 1.3 with DisplayPortTM amendment Revision 1.1.
 - ♦ Secure ASSR (Alternate Scrambler Seed Reset) support for embedded DisplayPort[™] panels
 - Stream Policy Maker is assumed handled by the Host (software/firmware).
 - Start Link training in response to HPD & read final Link training status
 - Configure DP link for actual video streaming & start video streaming
 - ♦ Link Policy maker is assumed shared between the Host and TC358867XBG chip.
 - In auto correction = 0 mode, control link training
 - Initiate Display device capabilities read and configure TC358867XBG accordingly.



- ♦ Video timing generation as per panel requirement.
- ♦ SSCG with to 30 kHz modulation to reduce EMI.
- ♦ Built in PRBS7 Generator to test DisplayPortTM Link.

• RGB Parallel Output Interface:

- ♦ RGB888 output (DisplayPortTM disabled) with only DSI input supported in this mode
- ♦ PCLK max. = 100 MHz
- ♦ Polarity control for PCLK, VSYNC, HSYNC & DE

I²C Interface:

- ♦ I²C slave interface for chip register set access enabled using a boot-strap option.
- ♦ I²C compliant slave interface support for normal (100 kHz) and fast mode (400 kHz).

GPIO Interface:

- ♦ 2 bits of GPIO (shared with other digital logic).
- ♦ Direction controllable by Host I²C accesses.

Clock Source:

- DisplayPort™ clock source is from an external clock input or clock from DSI interface (13, 26, 19.2 or 38.4 MHz) generates all internal & output clocks to interfacing display devices.
- ♦ Built-in PLLs generate high-speed DisplayPortTM link clock requiring no external components. These PLLs are part of the DisplayPortTM PHY.
- Clock and power management support to achieve low power states.

• Possible modes of Operation:

- ♦ MODE S21: TC358867XBG uses DisplayPortTM Tx as single 2-lane DisplayPortTM link to interface to single DisplayPortTM display device. Video stream source is from MIPI[®] DSI Host.
- → MODE P21: TC358867XBG uses DisplayPortTM Tx as single 2-lane DisplayPortTM link to interface to single DisplayPortTM display device. Video stream source is from MIPI® DPI Host.
- ♦ MODE S2P: TC358867XBG uses only Parallel output port and disables DisplayPortTM Tx to interface to single RGB display device. Video stream source is from MIPI[®] DSI Host.

• Power supply inputs

♦ Core and MIPI® D-PHY: $1.2 \text{ V} \pm 0.06 \text{ V}$ ♦ Digital I/O: $1.8 \text{ V} \pm 0.09 \text{ V}$ ♦ DisplayPortTM: $1.8 \text{ V} \pm 0.09 \text{ V}$ • DisplayPortTM: $1.2 \text{ V} \pm 0.06 \text{ V}$

• Power Consumptions (Typical value based on estimations)

♦ Power-down mode (DSI-Rx in ULPS, DP PHY & PLLs disabled, clocks stopped):

DSI Rx: 0.01 mW
 DP PHY: 2.34 mW
 PLL9: 0.01 mW
 Core: 0.96 mW
 Rest: 0.01 mW

♦ Normal operation (1920×1080 resolution with DSI-Rx in 4-lane @925 Mbps per lane, DP PHY in dual lane link @2.7 Gbps per lane):

DSI Rx: 21.79 mW
 DP PHY: 142.70 mW
 PLL9: 2.42 mW
 Core: 87.64 mW
 IOs: 1.68 mW

Package

- 0.65mm ball pitch, 80 balls, 7 × 7 mm BGA package

Note: Attention about ESD. This product is weak against ESD. Please handle it carefully.



Table 2.1 TC358867XBG operational modes summary with panel size support inform
--

Mada	Input Confi	guration	Register Access	Max Panel		
Mode	DSI input	DPI input	Method	size example		
S21	Active	Х	DSI or I ² C	WUXGA 18bpp @ 60fps WUXGA 24bpp @ 60fps		
P21	X	Active	I ² C	WUXGA 24bpp @ 60fps		

Tables below provide an idea of different panel sizes that can be supported by using different data link lane configurations.

Table 2.2 Panel Size v/s Data link required by TC358867XBG in DSI input case

	Frame Size		RGB666					RGB888				
		With OverHead	FPS	Pixel Clock (MHz)	Bit Rate (Gbps)	# DSI Data	# DP linl		Bit Rate (Gbps)	# DSI Data	# DP Ma	in links
		Overrieau		(land		1.62G	2.7G	(Cops)	lanes	1.62G	2.7G
XGA	1024×768	1184×790	60	56	1.01	2	1	1	1.34	2	2	1
WXGA+ / WSXGA	1440×900	1600×926	60	89	1.60	2	2	1	2.13	3	2	1
SXGA+	1400×1050	1560×1080	60	89	1.82	2	2	1	2.43	3	2	2
WSXGA+	1680×1050	1840×1080	60	119	2.15	3	2	1	2.86	3	_	2
UXGA	1600×1200	1760×1235	60	130	2.35	3	2	2	3.13	4	-	2
WUXGA	1920×1200	2080×1235	60	154	2.77	3	_	2	3.70	4	_	2

Table 2.3 Panel Size v/s Data link required by TC358867XBG in DPI input case

	Frame Size						RGB666			RGB888		
		With OverHead	FPS Clock (MHz)		DPI Support 154 MHz PCLK	Bit Rate (Gbps)	# DP lin		Bit Rate (Gbps)		Main ıks	
		Overrieau		(111112)	I OLK	(Gups)	1.62G	2.7G	(Gups)	1.62G	2.7G	
XGA	1024×768	1184×790	60	56	Yes	1.01	1	1	1.34	2	1	
WXGA+ / WSXGA	1440×900	1600×926	60	89	Yes	1.60	2	1	2.13	2	1	
SXGA+	1400×1050	1560×1080	60	89	Yes	1.82	2	1	2.43	2	2	
WSXGA+	1680×1050	1840×1080	60	119	Yes	2.15	2	1	2.86	1	2	
UXGA	1600×1200	1760×1235	60	130	Yes	2.35	2	2	3.13	ı	2	
WUXGA	1920×1200	2080×1235	60	154	Yes	2.77	_	2	3.70	_	2	

Note: These are the formats commonly used by displays. Support for other sizes is possible as long

as they satisfy the maximum data rate constraints on the DSI and DisplayPortTM link

interfaces.

Note: Throughout the rest of the document, "DP" is used to denote "DisplayPort™". Both

these words have been used interchangeably and refer to the VESA[®] DisplayPort[™]

specification as mentioned in the references.



3. External Pins

3.1. TC358867XBG External Pins

TC358867XBG uses an 80ball package. Following table gives the signals of TC358867XBG and their function.

Table 3.1 TC358867XBG Functional Signal List for 80-ball Package

Group	Pin Name	1/0	Туре	Function	Note
	RESX	I	Sch	System Reset – active Low 0: Reset 1: Normal operation	
	REFCLK	I	Sch	13, 26, 19.2 or 38.4 MHz 50ps phase jitter p2p/ WC duty cycle 40-60%	_
	INT	0	N	Interrupt to Host – active High 0: No interrupt is generated 1: Interrupt is generated	4mA
System:	DISABLE_ASSR	I	N	ASSR control 0: Enable ASSR 1: Disable ASSR	_
Reset, Clock, Mode select, Test (9)	MODE[1:0]	I	N	Mode Selection pins MODE_0: 0: REFCLK is source of internal DP PLL 1: When REFCLK="0", DSI clock is source of internal DP PLL. When REFCLK="1", DPI PCLK is source of internal DP PLL. MODE_1: When MODE_0="1" & REFCLK="0" this pin will be effective. 0: DSI clock/2/7 is source of internal DP PLL. 1: DSI clock/2/9 is source of internal DP PLL.	ı
	TEST	I	N	Test Pin - active high 0: Normal operation 1: Test mode	
	TEST3	0	N	Test Pin, Open	_
	VPGM0	NA —		eFUSE programming voltage. Connect to GND	_
	DSICP	ı	MIPI®-PHY	MIPI®-DSI Rx Clock Lane Pos.	_
	DSICM	ı	MIPI®-PHY	MIPI®-DSI Rx Clock Lane Neg.	_
DSI Rx	DSIDP0	I/O	MIPI®-PHY	MIPI®-DSI Rx Data Lane Pos.	_
(10)	DSIDM0	I/O	MIPI®-PHY	MIPI®-DSI Rx Data Lane Neg.	_
	DSIDP[3:1]	ı	MIPI®-PHY	MIPI®-DSI Rx Data Lane Pos.	_
	DSIDM[3:1]	I	MIPI®-PHY	MIPI®-DSI Rx Data Lane Neg.	_
	DPLNP[1:0]	0	DP-PHY	embedded DisplayPort™ Output Main Link Pos.	_
DD 6 :	DPLNM[1:0]	0	DP-PHY	embedded DisplayPort™ Output Main Link Neg.	_
DP Out (8)	DPAUXP	I/O	DP-PHY	embedded DisplayPort™ Output AUX Channel Pos	_
(3)	DPAUXM	I/O	DP-PHY	embedded DisplayPort™ Output AUX Channel Neg	_
	PREC_RES[1:0]	I	DP-PHY	Precision Resistance (3kΩ @ 1%) connection	-
	DPI_PCLK	I/O	N	DPI Pixel Clock (max 154 MHz) (default: Input)	4mA
DPI Tx/Rx	DPI_VSYNC	1/0	N	DPI Vertical Sync (default: Input)	4mA
(28)	DPI_HSYNC	1/0	N	DPI Poto Englis (default: Input)	4mA
	DPI_DE DPI_D [23:0]	I/O I/O	N N	DPI Data Enable (default: Input) DPI Parallel Data (default: Input)	4mA 4mA
	12C_SCL	OD	Sch	I ² C Clock	
	I2C_SCL	OD	Sch	I ² C Data	4mA
I ² C (3)	I2C_ADR_SEL	I	N	I ² C Slave Address Select 0: Slave address=7'b1101_000 1: Slave address=7'b0001_111	_

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	SD/I2S_OSCLK	-	N	I2S Over Sampling Clock	_
I2S	I2S_BCLK		N	I2S Bit Clock (max 12.5 MHz)	_
(4)	I2S_LRCLK	I	N	I2S sample clock (max 192 kHz)	_
	I2S_DATA	1	N	I2S Data	_
GPIO (2)	GPIO[1:0]	OD	5T-OD	GPIO or Test Control *Note1 GPIO[1:0] can be used for HPD support	4mA
	VDDC (1.2V)	NA	_	VDD for Internal Core (2)	_
	VDDS (1.8V)	NA	_	VDDS for IO Ring power supply (1)	_
DOWED	VDD_PLL18 (1.8V)	NA	_	VDD for DP PHY PLLs (1)	_
POWER (10)	VDD_DP18 (1.8V)	NA	_	VDD for DP PHY Main Channels (2)	_
(10)	VDD_PLL912 (1.2V)	NA	_	VDD for PLL9 (1)	_
	VDD_DP12 (1.2V)	NA	_	VDD for DP PHY (2)	_
	VDD_DSI12 (1.2V)	NA	_	VDD for the MIPI® DSI PHY (1)	_
GROUND	VSS	NA	_	Ground (Core, DSI, I/O) (3)	_
(6)	VSS_DP	NA	_	Ground (DP) (3)	_

Note 1: Pins with multiplexed Functional mode functions.

N: Normal IO

PHY: Either DP analog front end or MIPI® D-PHY

Sch: Schmitt trigger input

OD: Open drain

5T-OD: 5 V tolerant bi-direction buffer with Open drain

DPI_D22



REFCLK

VDD_DP18

DPLNM0

VDD_DP12

3.2. TC358867XBG Ball Mapping

The mapping of TC358867XBG signals to the external pins is given in the following figure. (BGA array)

Top View DPI_VSYNC DPI_D0 DPI_D3 I2C_SDA I2C_SCL DPI_DE DPI_HSYNC DPI_D1 DPI_D2 DPI_D4 DPI_D7 DSIDM0 DSIDP0 DPI_D5 DPI_D6 DSIDM1 DSIDP1 DPI_D9 DPI_D8 SD/ I2S_OSCLK DSICM DSICP I2S_LRCLK I2S_BCLK I2S_DATA DPI_D13 DPI_D14 I2C_ADR_SEL TEST3 VDD_DSI12 VPGM0 DPI_D10 DPI_D16 DPI_D15 VSS DSIDM2 DSIDP2 TEST DPI_D11 DPI_D17 DPI_D18 VSS VSS VSS_DP VSS_DP VSS_DP DPI_D12 DPI_PCLK DSIDM3 DSIDP3 DPI_D19 DISABLE_ASSR PREC_RES0 DPI_D20 DPI_D21 PREC_RES1 MODE1 DPLNP0 VDD_DP12 MODE0 DPLNP1 GPIO1 DPAUXP RESX DPI_D23

VDD_PLL18

Figure 3.1 TC358867XBG 80-ball Layout

DPLNM1

VDD_DP18

DPAUXM

VDD_PLL912



4. Package

The package for TC358867XBG is described in the figure below.

Unit: mm

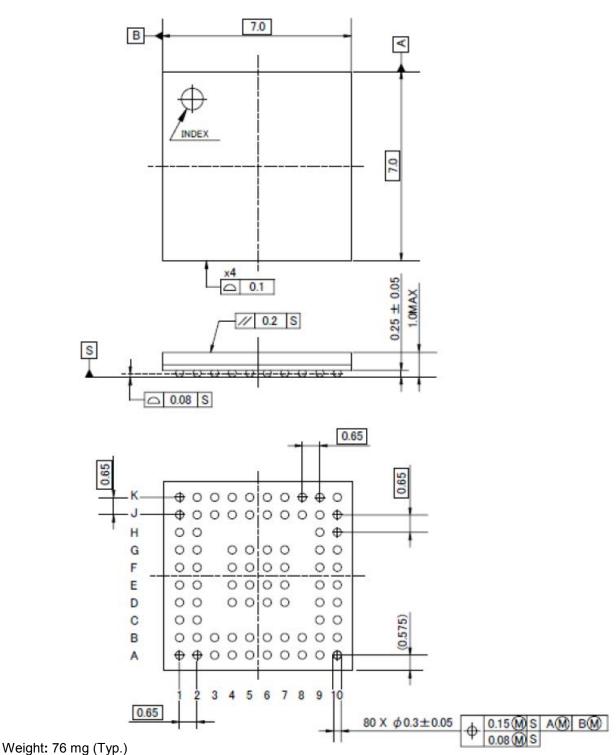


Figure 4.1 80 ball TC358867XBG package



5. Electrical Characteristics

5.1. Absolute Maximum Ratings

VSS/VSS_DP= 0 V reference

VDD18 used for VDDS, VDD_DP18 and VDD_PLL18; VDD12 used for VDDC, VDD_DSI12, VDD_DP12 and VDD_PLL912.

Parameter Unit **Symbol** Rating Supply voltage (1.8 V) VDD18 -0.3 to +3.5V Supply voltage (1.2 V) VDD12 -0.3 to +2.0 V VDD18 -0.3 to +3.5 ٧ Supply voltage (IO) -0.3 to +3.5 **VREF** V Input voltage VIN -0.3 to VDDS+0.3 ٧ Output voltage **VOUT** -0.3 to VDDS+0.3 °C Storage temperature Tstg -40 to +125

Table 5.1 Absolute Maximum Ratings

5.2. Operating Condition

VSS/VSS_DP = 0 V reference

VDD18 used for VDDS, VDD_DP18 and VDD_PLL18; VDD12 used for VDDC, VDD_DSI12, VDD_DP12 and VDD_PLL912.

_	-	•			
Parameter	Symbol	Min	Тур.	Max	Unit
Supply voltage (1.8 V)	VDD18	1.71	1.8	1.89	V
Supply voltage (1.2 V)	VDD12	1.14	1.2	1.26	V
Operating frequency (internal)	Fopr	_	_	200	MHz
Operating temperature	Та	-20	_	+85	°C

Table 5.2 Operating Condition



5.3. DC Electrical Specification

VSS/VSS_DP = 0V reference

Table 5.3 DC Electrical Specification

Parameter	Symbol	Min	Тур.	Max	Unit
Input voltage High level CMOS input Note1	VIH	0.7 VDDS	_	VDDS	V
Input voltage Low level CMOS input Note1	VIL	0	_	0.3 VDDS	V
Input voltage High level CMOS Schmitt Trigger Note1	VIHS	0.7 VDDS	_	VDDS	V
Input voltage Low level CMOS Schmitt Trigger Note1	VILS	0	_	0.3 VDDS	V
Output voltage High level Note1, Note2	VOH	0.8 VDDS	_	VDDS	V
Output voltage Low level Note1, Note2	VOL	0	_	0.2 VDDS	V
Input leak current High level	IIH1 (Note3)	-10	_	10	μA
Input look ourrent Low lovel	IIL1 (Note4)	-10	_	10	μΑ
Input leak current Low level	IIL2 (Note5)	-200	_	-10	μΑ

Note1: VDDS within recommended operating condition.

Note2: Output current value is according to each IO buffer specification. Output voltage changes

with output current value.

Note3: Normal pin, or Pull-up I/O pin applied VDDS supply voltage to input pin

Note4: Normal pin applied VSS (0 V) to input pin Note5: Pull-up I/O pin applied VSS (0 V) to input pin

5.4. Power Consumption (Typical value based on estimation)

Typical power consumption as measured for the power-down modes and for normal operation are provided below:

Power-down mode (DSI-Rx in ULPS, DP PHY & PLLs disabled, clocks stopped):

DSI Rx: 0.01 mW
 DP PHY: 2.34 mW
 PLL9: 0.01 mW
 Core: 0.96 mW
 Rest: 0.01 mW

 Normal operation (1920×1080 resolution with DSI-Rx in 4-lane @925 Mbps per lane, DP PHY in dual lane link @2.7 Gbps per lane):

♦ DSI Rx: 21.79 mW
 ♦ DP PHY: 142.70 mW
 ♦ PLL9: 2.42 mW
 ♦ Core: 87.64 mW
 ♦ IOs: 1.68 mW



6. Revision History

Table 6.1 Revision History

Revision	Date	Description
0.1	2017-12-27	Newly released (Preliminary)
0.2	2018-01-25	"Overview"/"Feature" description is updated. Table 3-1 is modified and updated. Figure 3-1 is updated.
0.3	2018-02-20	Modified weight. Added descriptions of the last page.
1.0	2018-03-27	Deleted descriptions of the last page. Modified descriptions of the trademarks. Modified Figure 1.1, Figure 1.2 and Figure 1.3. Corrected typos. Modified descriptions in Features. Officially released.
1.1	2018-05-28	Modified Table 2.2 and Table 2.3.



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